



#4/7
2/8/1
Mollu
RECEIVED

FEB 5 2002
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

TC 2800 MAIL ROOM

In re Application of:

Farnworth et al.

Serial No.: 09/923,687

Filed: August 6, 2001

For: HERMETIC CHIP AND METHOD OF
MANUFACTURE

Examiner: Unknown

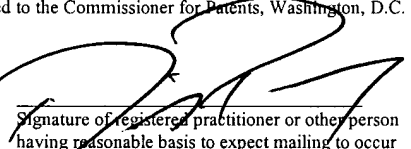
Group Art Unit: 2823

Attorney Docket No.: 2741.5US (95-0804.4)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

January 22, 2002
Date of Deposit


Signature of registered practitioner or other person
having reasonable basis to expect mailing to occur
on date of deposit shown pursuant to 37 C.F.R. §
1.8(a)(1)(ii)

Deidra Pfeil
Typed/printed name of person whose signature is
contained above

PRELIMINARY AMENDMENT

Box Non-Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination of the above-referenced patent application on the merits, entry of the amendments as set forth herein is respectfully solicited.